

UTC UNISONIC TECHNOLOGIES CO., LTD

BSS84ZT **Power MOSFET**

0.13A, 50V P-CHANNEL ENHANCEMENT MODE FIELD EFFECT TRANSISTOR

DESCRIPTION

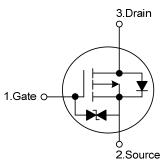
These P-Channel enhancement mode field vertical D-MOS transistors are in a SOT-523 SMD package, and in most applications they require up to 0.13A DC and can deliver current up to 0.52A.

This product is particularly suited to low voltage applications requiring a low current high side switch.



* $R_{DS(ON)} \le 10\Omega$ @ V_{GS} =-4.5V, I_{D} =-0.1A

SYMBOL



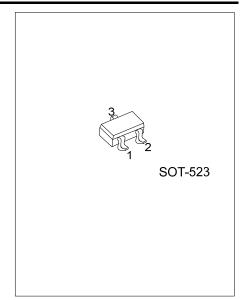
ORDERING INFORMATION

Ordering Number		Dackage	Pin Assignment			Dooking	
Lead Free	Halogen Free	- Package	1	2	3	Packing	
BSS84ZTL-AN3-R	BSS84ZTG-AN3-R	SOT-523	G	S	D	Tape Reel	

Note: Pin Assignment: G: Gate S: Source D: Drain BSS84ZTG-AN3-R (1)Packing Type (1) R: Tape Reel - (2)Package Type (2) AN3: SOT-523 (3)Green Package (3) G: Halogen Free and Lead Free, L: Lead Free

MARKING





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■ ABSOLUTE MAXIMUM RATINGS (T_A = 25°C, unless otherwise specified)

PARAMETER		SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		V_{DSS}	-50	V	
Gate-Source Voltage		V_{GSS}	±20	V	
Cantinuous Drain Current	DC		-0.13	^	
Continuous Drain Current	Pulse	I _D	-0.52	Α	
Power Dissipation		P_D	0.15	W	
Junction Temperature		TJ	+150	°C	
Storage Temperature		T _{STG}	-55 ~ + 150	°C	

Note: Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

■ THERMAL CHARACTERISTICS

PARAMETER	SYMBOL RATINGS		UNIT	
Junction to Ambient	θ_{JA}	625	°C/W	

■ ELECTRICAL CHARACTERISTICS (T_A=25°C, unless otherwise specified)

PARAMETER	SYMBOL	TEST CONDITIONS	MIN	TYP	MAX	UNIT		
OFF CHARACTERISTICS								
Drain-Source Breakdown Voltage	BV _{DSS}	V_{GS} =0V, I_D =-250 μ A	-50			V		
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =-50V, V _{GS} =0V			-15	μΑ		
Gate-Body Leakage, Forward	I_{GSS}	V_{DS} =0V, V_{GS} =±20V			±10	μΑ		
ON CHARACTERISTICS (Note)								
Gate-Threshold Voltage	$V_{GS(TH)}$	V _{DS} =V _{GS} , I _D =-1m A	-0.8	-1.7	-2	V		
Static Drain-Source On-Resistance	R _{DS(ON)}	V _{GS} =-4.5V, I _D =-0.1A		1.2	10	Ω		
On-State Drain Current	$I_{D(ON)}$	V _{GS} =-10 V, V _{DS} =-5V	-0.6			Α		
Forward Transconductance	g FS	V _{DS} =-25V, I _D =-0.1A	0.05	0.6		S		
DYNAMIC PARAMETERS								
Input Capacitance	C _{ISS}			73		pF		
Output Capacitance	Coss	V_{DS} =-25V, V_{GS} =0V, f=1MHz		10		pF		
Reverse Transfer Capacitance	C_{RSS}]		5		pF		
SWITCHING PARAMETERS (Note)	_							
Total Gate Charge	Q_{G}	V = 20V V = 40V		0.9	1.3	nC		
Gate Source Charge	Q_GS	V _{DS} =-30V, V _{GS} =-10V, I _D =-0.1A		0.2		nC		
Gate Drain Charge	Q_GD	ID0. IA		0.3		nC		
Turn-ON Delay Time	t _{D(ON)}			2.5	5	ns		
Turn-ON Rise Time	t_R	V_{DD} =-30V, I_{D} =-0.1A, V_{GS} =-10V,		6.3	13	ns		
Turn-OFF Delay Time	t _{D(OFF)}	$R_G=6\Omega$,		10	20	ns		
Turn-OFF Fall-Time	t_{F}			4.8	9.6	ns		
SOURCE- DRAIN DIODE RATINGS AND CHARACTERISTICS								
Max. Diode Forward Current	Is				-0.13	Α		
Pulsed Drain-Source Current	I _{SM}				-0.52	Α		
Drain-Source Diode Forward Voltage	V _{SD}	V _{GS} = 0V, I _S =-0.13A (Note)		-0.8	-1.2	V		

Note: Pulse test, pulse width ≤ 300us, duty cycle≤ 2%

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